

### Features

- Green Device Available
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Advanced high cell density Trench technology

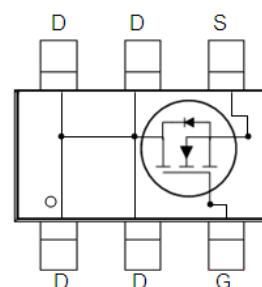
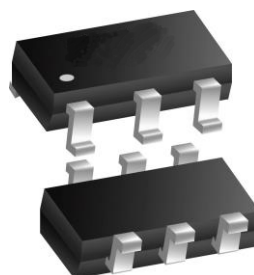
### Description

The JHT63002 is the high cell density trenched N-ch MOSFETs, which provides excellent R<sub>DS(on)</sub> and efficiency for most of the small power switching and load switch applications. The JHT63002 meet the RoHS and Green Product requirement with full function reliability approved.

### Product Summary

BVDSS	R <sub>DS(on)</sub>	I <sub>D</sub>
30V	28mΩ	5A

### SOT-23-6 Pin Configuration



### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	30	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>A</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	5	A
I <sub>D</sub> @T <sub>A</sub> =70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	4	A
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	10	A
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation <sup>3</sup>	1.1	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C

### Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction-ambient <sup>1</sup>	---	110	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>	---	70	°C/W

## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	30	---	---	V
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	BVDSS Temperature Coefficient	Reference to 25°C, I <sub>D</sub> =1mA	---	0.02	---	V/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =5A	---	---	28	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =4A	---	---	40	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.0	---	2.5	V
ΔV <sub>GS(th)</sub>	V <sub>GS(th)</sub> Temperature Coefficient		---	-4.6	---	mV/°C
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =24V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C	---	---	1	uA
		V <sub>DS</sub> =24V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C	---	---	5	
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	---	---	±100	nA
g <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =5A	---	6.3	---	S
R <sub>g</sub>	Gate Resistance	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz	---	2.5	5	Ω
Q <sub>g</sub>	Total Gate Charge (4.5V)	V <sub>DS</sub> =20V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A	---	7.2	---	nC
Q <sub>gs</sub>	Gate-Source Charge		---	1.4	---	
Q <sub>gd</sub>	Gate-Drain Charge		---	2.2	---	
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =12V, V <sub>GS</sub> =10V, R <sub>G</sub> =3.3Ω I <sub>D</sub> =5A	---	4.1	---	ns
T <sub>r</sub>	Rise Time		---	9.8	---	
T <sub>d(off)</sub>	Turn-Off Delay Time		---	15.5	---	
T <sub>f</sub>	Fall Time		---	6.0	---	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1MHz	---	572	---	pF
C <sub>oss</sub>	Output Capacitance		---	81	---	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	65	---	

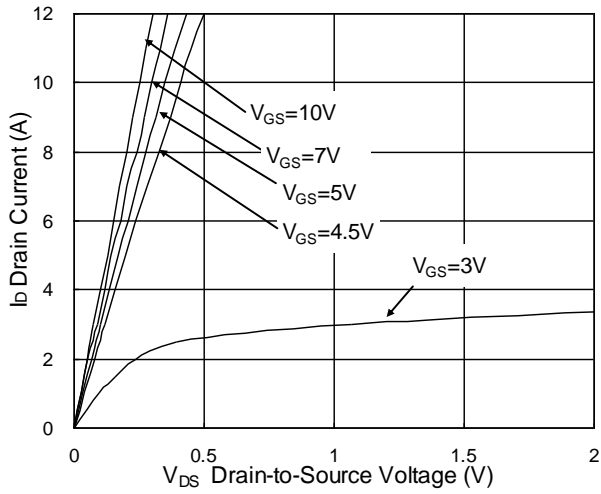
### Diode Characteristics

I <sub>S</sub>	Continuous Source Current <sup>1,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current	---	---	5	A
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>		---	---	10	A
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V, I <sub>S</sub> =1A, T <sub>J</sub> =25°C	---	---	1.2	V

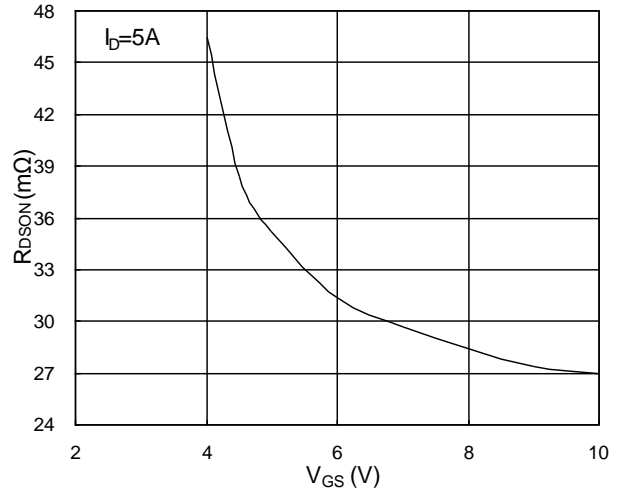
Note :

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%
- 3.The power dissipation is limited by 150°C junction temperature
- 4.The data is theoretically the same as I<sub>D</sub> and I<sub>S</sub>, in real applications, should be limited by total power dissipation.

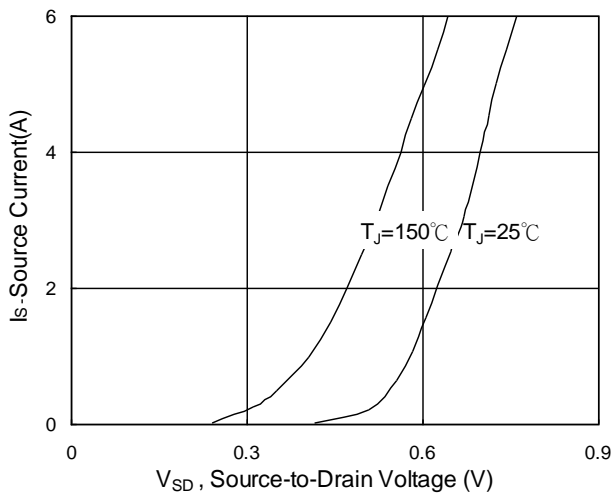
**Typical Characteristics**



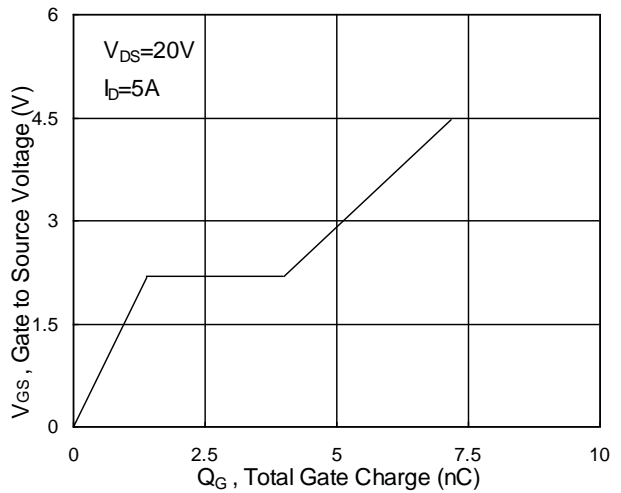
**Fig.1 Typical Output Characteristics**



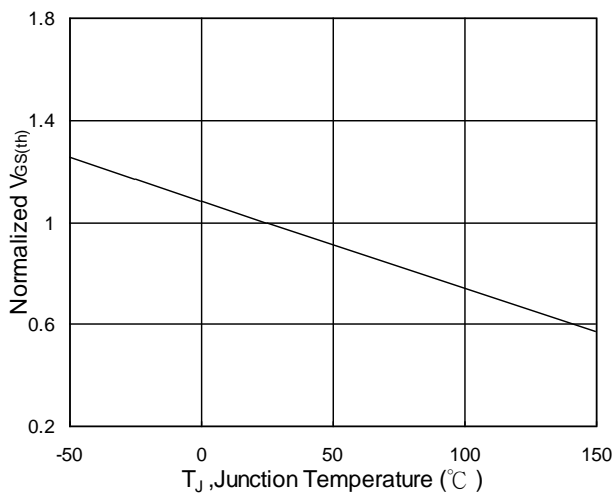
**Fig.2 On-Resistance vs. Gate-Source**



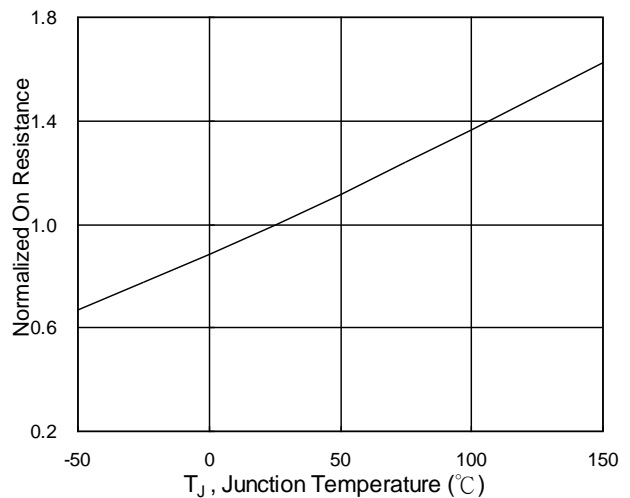
**Fig.3 Forward Characteristics Of Reverse**



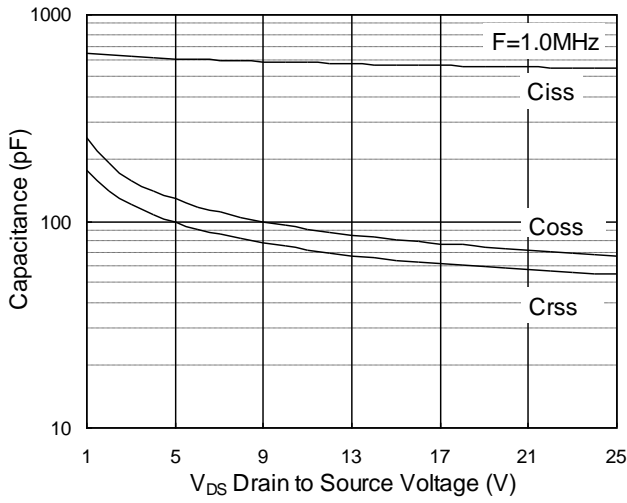
**Fig.4 Gate-Charge Characteristics**



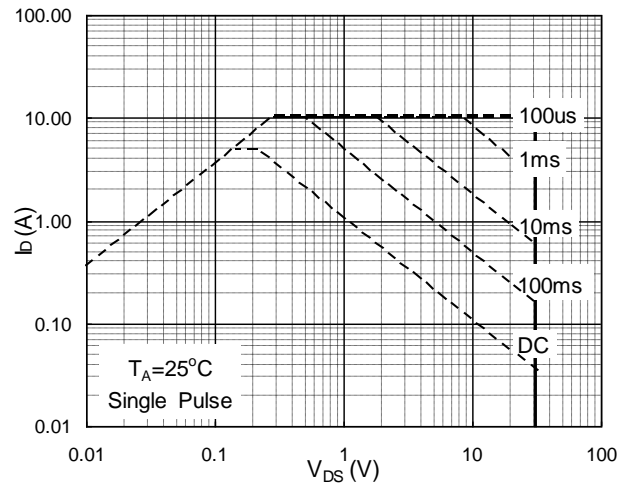
**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$**



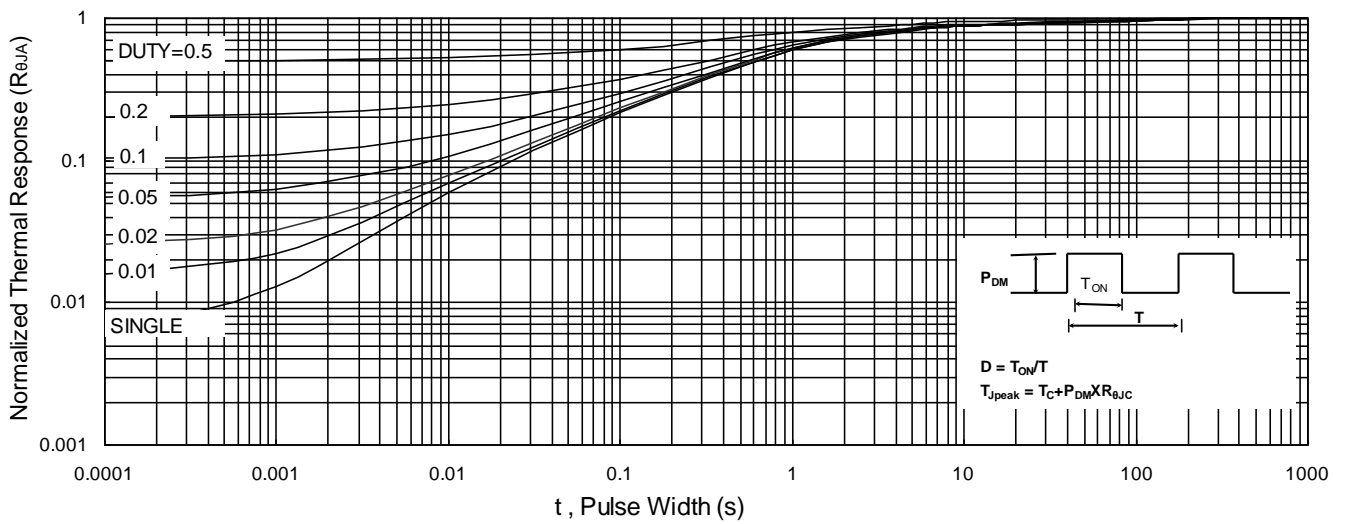
**Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$**



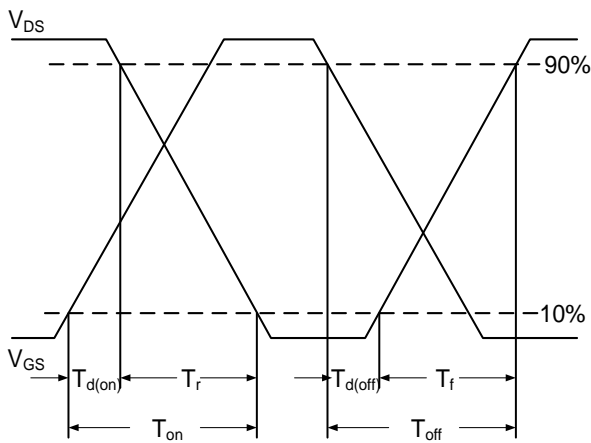
**Fig.7 Capacitance**



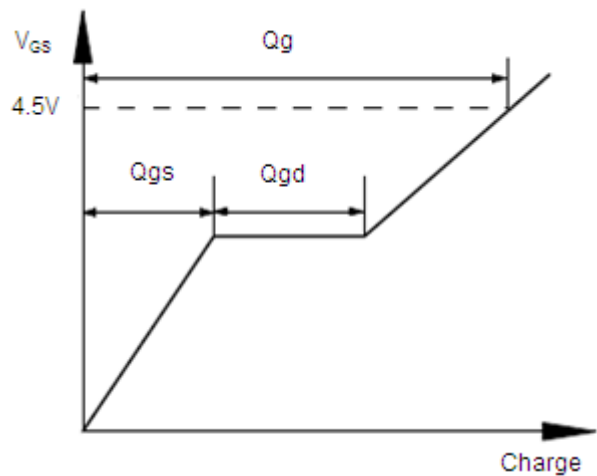
**Fig.8 Safe Operating Area**



**Fig.9 Normalized Maximum Transient Thermal Impedance**

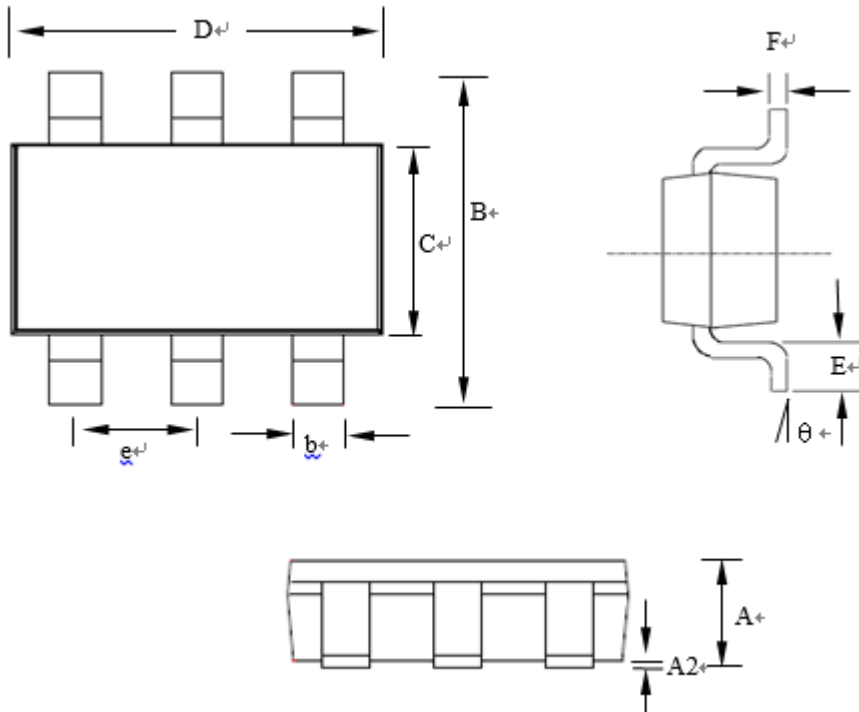


**Fig.10 Switching Time Waveform**



**Fig.11 Gate Charge Waveform**

## SOT-23-6 Package Outline Dimensions



SYMBOLS	MILLIMETERS $\varnothing$			INCHES $\varnothing$		
	MIN $\varnothing$	NOM $\varnothing$	MAX $\varnothing$	MIN $\varnothing$	NOM $\varnothing$	MAX $\varnothing$
A $\varnothing$	0.70 $\varnothing$	-- $\varnothing$	0.9 $\varnothing$	0.028 $\varnothing$	-- $\varnothing$	0.035 $\varnothing$
A2 $\varnothing$	0.00 $\varnothing$	-- $\varnothing$	0.10 $\varnothing$	0.000 $\varnothing$	-- $\varnothing$	0.004 $\varnothing$
B $\varnothing$	2.60 $\varnothing$	2.80 $\varnothing$	3.00 $\varnothing$	0.102 $\varnothing$	0.110 $\varnothing$	0.118 $\varnothing$
C $\varnothing$	1.40 $\varnothing$	1.60 $\varnothing$	1.80 $\varnothing$	0.055 $\varnothing$	0.063 $\varnothing$	0.071 $\varnothing$
D $\varnothing$	2.70 $\varnothing$	2.90 $\varnothing$	3.10 $\varnothing$	0.106 $\varnothing$	0.114 $\varnothing$	0.122 $\varnothing$
E $\varnothing$	0.30 $\varnothing$	0.40 $\varnothing$	0.60 $\varnothing$	0.012 $\varnothing$	0.016 $\varnothing$	0.024 $\varnothing$
F $\varnothing$	0.07 $\varnothing$	0.127 $\varnothing$	0.20 $\varnothing$	0.003 $\varnothing$	0.005 $\varnothing$	0.008 $\varnothing$
b $\varnothing$	0.30 $\varnothing$	0.40 $\varnothing$	0.50 $\varnothing$	0.012 $\varnothing$	0.016 $\varnothing$	0.020 $\varnothing$
e $\varnothing$	-- $\varnothing$	0.95 $\varnothing$	-- $\varnothing$	-- $\varnothing$	0.037 $\varnothing$	-- $\varnothing$
$\theta$ $\varnothing$	0 $^{\circ}$ $\varnothing$	5 $^{\circ}$ $\varnothing$	10 $^{\circ}$ $\varnothing$	0 $^{\circ}$ $\varnothing$	5 $^{\circ}$ $\varnothing$	10 $^{\circ}$ $\varnothing$

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